

## General Description

The AGM618MA combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

## Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

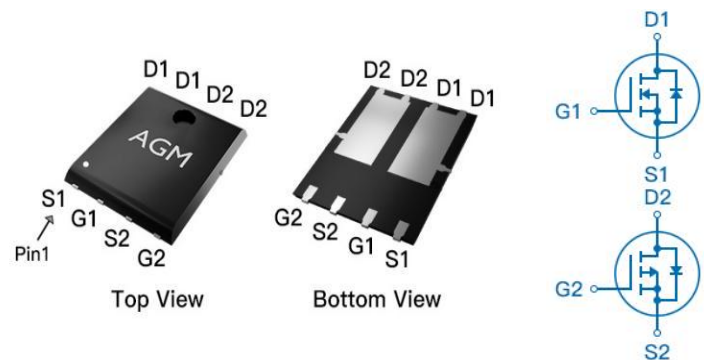
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## Product Summary

| BVDSS | RDSON | ID   |
|-------|-------|------|
| 60V   | 14mΩ  | 30A  |
| -60V  | 26mΩ  | -30A |

## PDFN5\*6 Pin Configuration



## Package Marking and Ordering Information

| Device Marking | Device   | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| AGM618MA       | AGM618MA | PDFN5*6        | 330mm     | 12mm       | 3000     |

Table 1. Absolute Maximum Ratings (TC=25°C)

| Symbol      | Parameter                                        | Rating     |            | Units |
|-------------|--------------------------------------------------|------------|------------|-------|
|             |                                                  | N-Ch       | P-Ch       |       |
| VDS         | Drain-Source Voltage (VGS=0V)                    | 60         | -60        | V     |
| VGS         | Gate-Source Voltage (VDS=0V)                     | ±20        | ±20        | V     |
| ID          | Drain Current-Continuous(Tc=25°C) (Note 1)       | 30         | -30        | A     |
|             | Drain Current-Continuous(Tc=100°C)               | 19         | -19        | A     |
| IDM (pulse) | Drain Current-Pulsed (Note 2)                    | 120        | -120       | A     |
| PD          | Maximum Power Dissipation(Tc=25°C)               | 51         | 51         | w     |
|             | Maximum Power Dissipation(Tc=100°C)              | 20         | 20         | w     |
| EAS         | Avalanche energy (Note 3)                        | 66         | 154        | mJ    |
| TJ,TSTG     | Operating Junction and Storage Temperature Range | -55 To 150 | -55 To 150 | °C    |

Table 2. Thermal Characteristic

| Symbol | Parameter                                                       | Typ | Max  | Unit |
|--------|-----------------------------------------------------------------|-----|------|------|
| RθJA   | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | --- | 20   | °C/W |
| RθJC   | Thermal Resistance Junction-Case <sup>1</sup>                   | --- | 2.45 | °C/W |

**Table 3. Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

| Symbol                             | Parameter                        | Conditions                          | Min | Typ  | Max  | Unit |
|------------------------------------|----------------------------------|-------------------------------------|-----|------|------|------|
| On/Off States                      |                                  |                                     |     |      |      |      |
| BVDSS                              | Drain-Source Breakdown Voltage   | VGS=0V ID=250μA                     | 60  | --   | --   | V    |
| IDSS                               | Zero Gate Voltage Drain Current  | VDS=60V,VGS=0V                      | --  | --   | 1    | μA   |
| IGSS                               | Gate-Body Leakage Current        | VGS=±20V,VDS=0V                     | --  | --   | ±100 | nA   |
| VGS(th)                            | Gate Threshold Voltage           | VDS=VGS,ID=250μA                    | 1.2 | --   | 2.2  | V    |
| gFS                                | Forward Transconductance         | VDS=5V,ID=20A                       | --  | 15   | --   | S    |
| RDS(on)                            | Drain-Source On-State Resistance | VGS=10V, ID=15A                     | --  | 14   | 18   | mΩ   |
|                                    |                                  | VGS=4.5V, ID=10A                    | --  | 17   | 22   | mΩ   |
| Dynamic Characteristics            |                                  |                                     |     |      |      |      |
| Ciss                               | Input Capacitance                | VDS=30V,VGS=0V,<br>F=1MHZ           | --  | 1480 | --   | pF   |
| Coss                               | Output Capacitance               |                                     | --  | 74   | --   | pF   |
| Crss                               | Reverse Transfer Capacitance     |                                     | --  | 70   | --   | pF   |
| Rg                                 | Gate resistance                  | VGS=0V,<br>VDS=0V,f=1.0MHz          | --  | 1.6  | --   | Ω    |
| Switching Times                    |                                  |                                     |     |      |      |      |
| td(on)                             | Turn-on Delay Time               | VGS=10V,VDS=30V,<br>RL=6.7Ω,RGEN=3Ω | --  | 7.5  | --   | nS   |
| tr                                 | Turn-on Rise Time                |                                     | --  | 5.1  | --   | nS   |
| td(off)                            | Turn-Off Delay Time              |                                     | --  | 28   | --   | nS   |
| tf                                 | Turn-Off Fall Time               |                                     | --  | 5.5  | --   | nS   |
| Qg                                 | Total Gate Charge                | VGS=10V, VDS=30V,<br>ID=20A         | --  | 50   | --   | nC   |
| Qgs                                | Gate-Source Charge               |                                     | --  | 6.0  | --   | nC   |
| Qgd                                | Gate-Drain Charge                |                                     | --  | 15   | --   | nC   |
| Source-Drain Diode Characteristics |                                  |                                     |     |      |      |      |
| ISD                                | Source-Drain Current(Body Diode) |                                     | --  | --   | 30   | A    |
| VSD                                | Forward on Voltage               | VGS=0V,IS=20A                       | --  | --   | 1.2  | V    |
| trr                                | Reverse Recovery Time            | IF=20A , dI/dt=100A/μs ,<br>TJ=25℃  | --  | 28   | --   | ns   |
| Qrr                                | Reverse Recovery Charge          |                                     | --  | 40   | --   | nc   |

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 3.EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=30V, V<sub>gs</sub>=10V, I<sub>D</sub>=21A, L=0.3mH, R<sub>G</sub>=25ohm

**Table 3. Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

| Symbol                             | Parameter                        | Conditions                            | Min  | Typ  | Max  | Unit |
|------------------------------------|----------------------------------|---------------------------------------|------|------|------|------|
| On/Off States                      |                                  |                                       |      |      |      |      |
| BVDSS                              | Drain-Source Breakdown Voltage   | VGS=0V ID=-250μA                      | -60  | --   | --   | V    |
| IDSS                               | Zero Gate Voltage Drain Current  | VDS=-60V,VGS=0V                       | --   | --   | -1   | μA   |
| IGSS                               | Gate-Body Leakage Current        | VGS=±20V,VDS=0V                       | --   | --   | ±100 | nA   |
| VGS(th)                            | Gate Threshold Voltage           | VDS=VGS,ID=-250μA                     | -1.2 | --   | -2.2 | V    |
| gFS                                | Forward Transconductance         | VDS=-5V,ID=-20A                       | --   | 27   | --   | S    |
| RDS(on)                            | Drain-Source On-State Resistance | VGS=-10V, ID=-15A                     | --   | 26   | 30   | mΩ   |
|                                    |                                  | VGS=-4.5V, ID=-10A                    | --   | 31   | 36   | mΩ   |
| Dynamic Characteristics            |                                  |                                       |      |      |      |      |
| Ciss                               | Input Capacitance                | VDS=-30V,VGS=0V,<br>F=1MHZ            | --   | 3600 | --   | pF   |
| Coss                               | Output Capacitance               |                                       | --   | 136  | --   | pF   |
| Crss                               | Reverse Transfer Capacitance     |                                       | --   | 124  | --   | pF   |
| Rg                                 | Gate resistance                  | VGS=0V,<br>VDS=0V,f=1.0MHz            | --   | 5.1  | --   | Ω    |
| Switching Times                    |                                  |                                       |      |      |      |      |
| td(on)                             | Turn-on Delay Time               | VGS=-10V,VDS=-30V,<br>RL=1.5Ω,RGEN=3Ω | --   | 15   | --   | nS   |
| tr                                 | Turn-on Rise Time                |                                       | --   | 13   | --   | nS   |
| td(off)                            | Turn-Off Delay Time              |                                       | --   | 94   | --   | nS   |
| tf                                 | Turn-Off Fall Time               |                                       | --   | 37   | --   | nS   |
| Qg                                 | Total Gate Charge                | VGS=-10V,<br>VDS=-30V, ID=-20A        | --   | 68   | --   | nC   |
| Qgs                                | Gate-Source Charge               |                                       | --   | 11   | --   | nC   |
| Qgd                                | Gate-Drain Charge                |                                       | --   | 13   | --   | nC   |
| Source-Drain Diode Characteristics |                                  |                                       |      |      |      |      |
| ISD                                | Source-Drain Current(Body Diode) |                                       | --   | --   | -30  | A    |
| VSD                                | Forward on Voltage               | VGS=0V,IS=-20A                        | --   | --   | -1.2 | V    |
| trr                                | Reverse Recovery Time            | IF=-20A , dl/dt=100A/μs ,<br>TJ=25℃   | --   | 23   | --   | ns   |
| Qrr                                | Reverse Recovery Charge          |                                       | --   | 21   | --   | nc   |

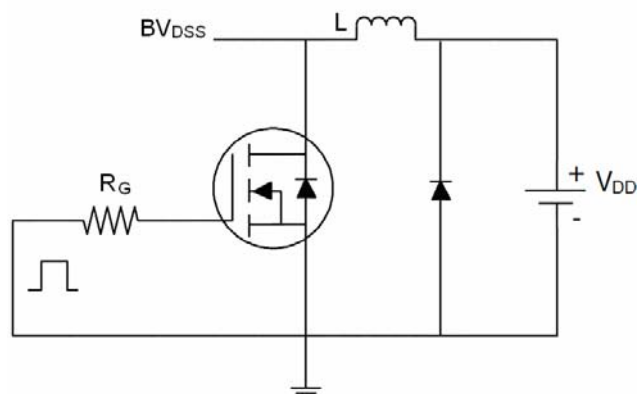
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature.

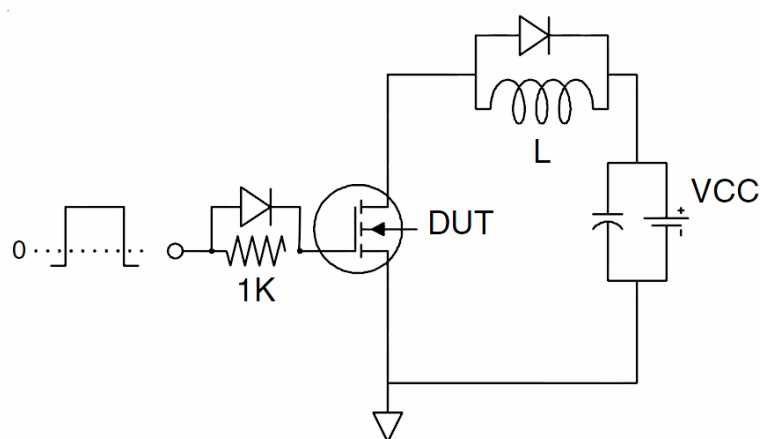
Notes 3.EAS condition: T<sub>J</sub>=25°C ,V<sub>DD</sub>=30V,V<sub>gs</sub>=10V,ID=32A, L=0.3mH,R<sub>G</sub>=25ohm

## Test Circuit

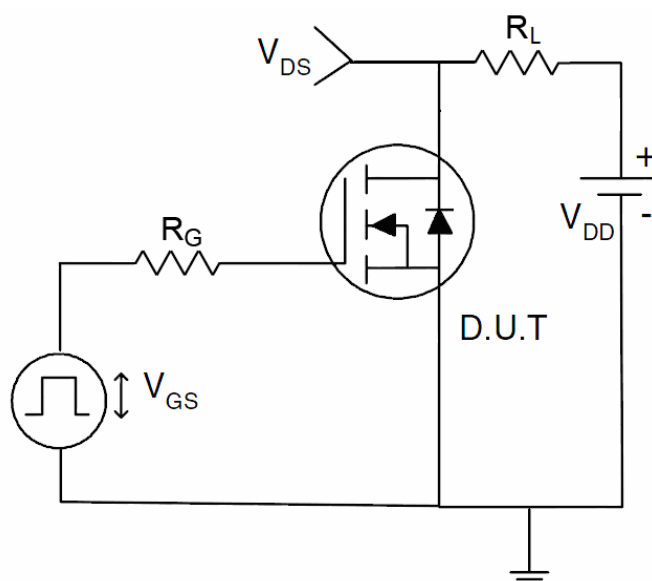
### 1) $E_{AS}$ test Circuit



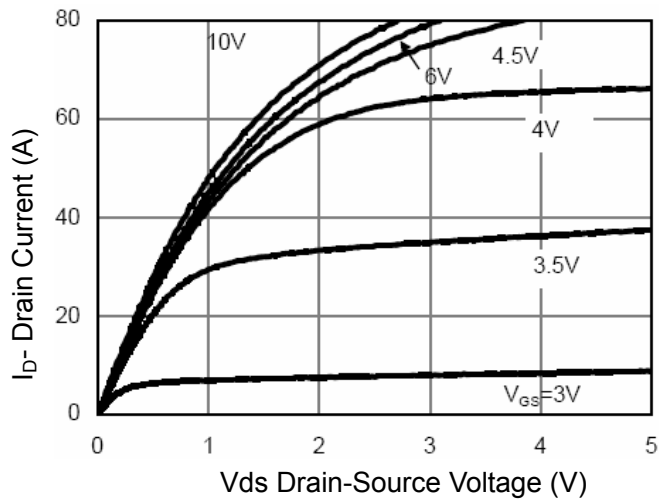
### 2) Gate charge test Circuit



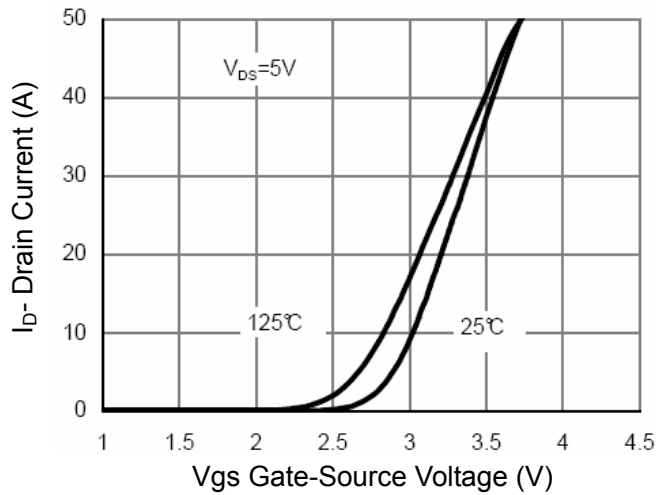
### 3) Switch Time Test Circuit



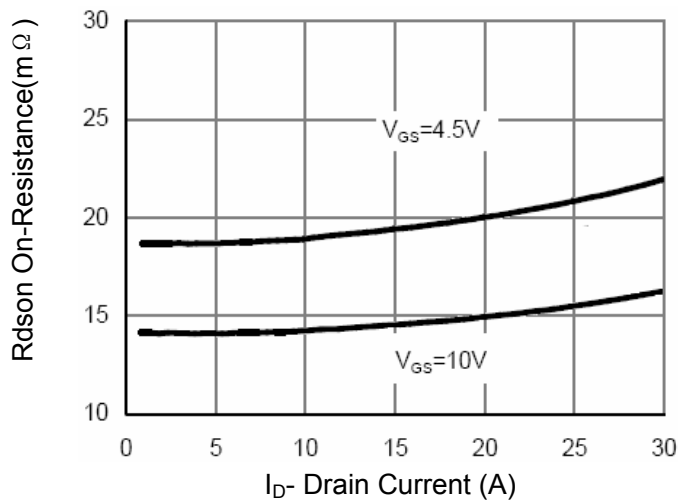
### N-Channel Typical Characteristics



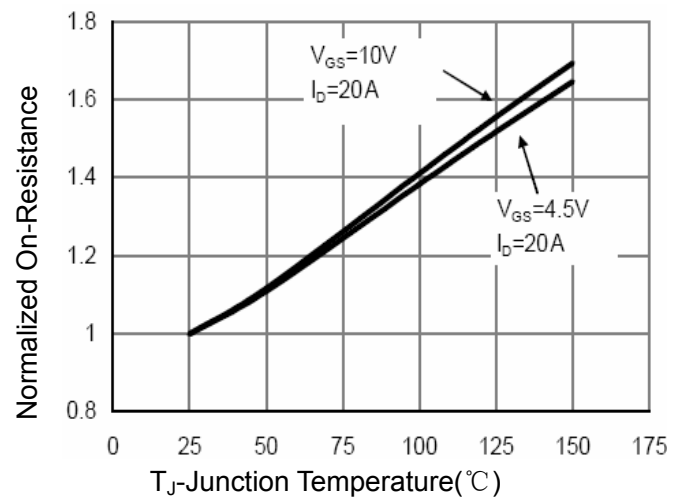
**Figure 1 Output Characteristics**



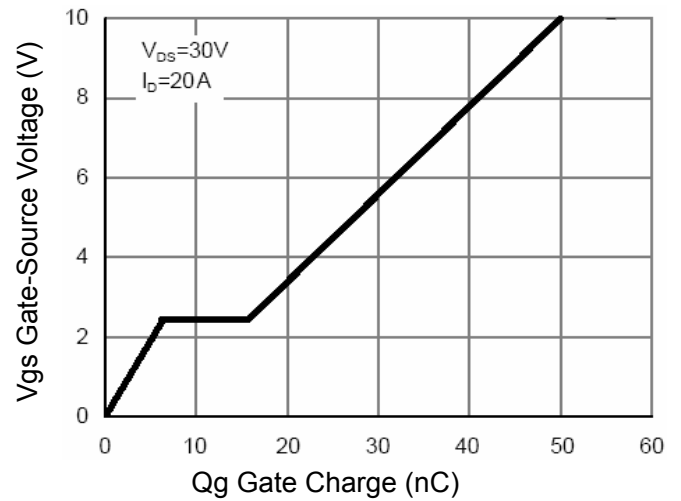
**Figure 2 Transfer Characteristics**



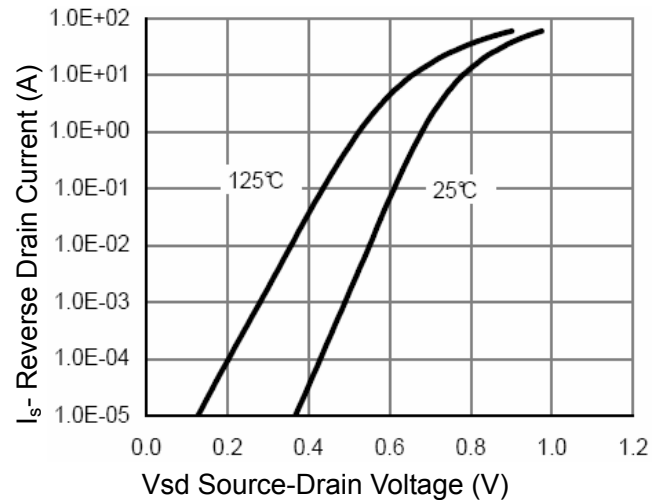
**Figure 3  $R_{DS(on)}$ - Drain Current**



**Figure 4  $R_{DS(on)}$ -Junction Temperature**



**Figure 5 Gate Charge**



**Figure 6 Source- Drain Diode Forward**

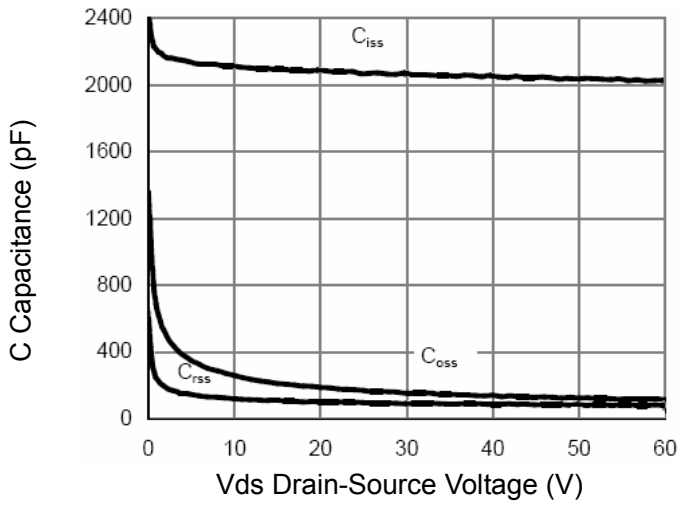


Figure 7 Capacitance vs Vds

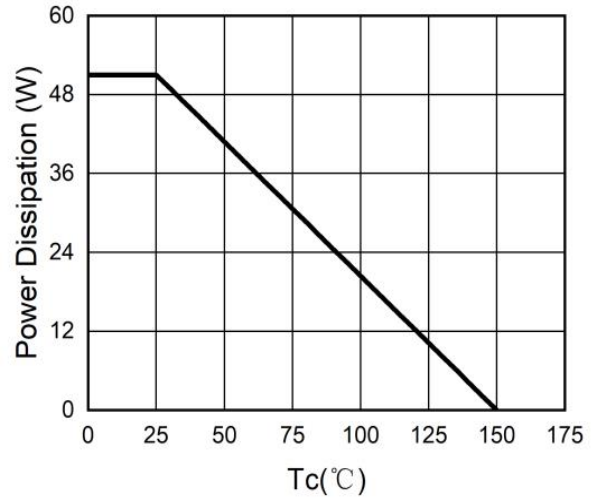


Figure 9 Power De-rating

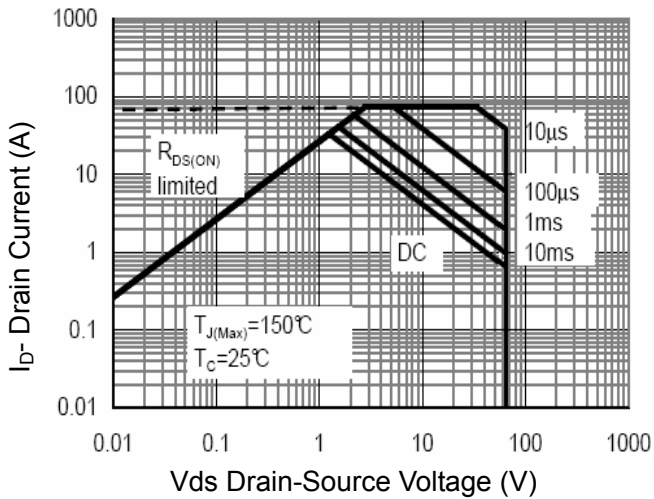


Figure 8 Safe Operation Area

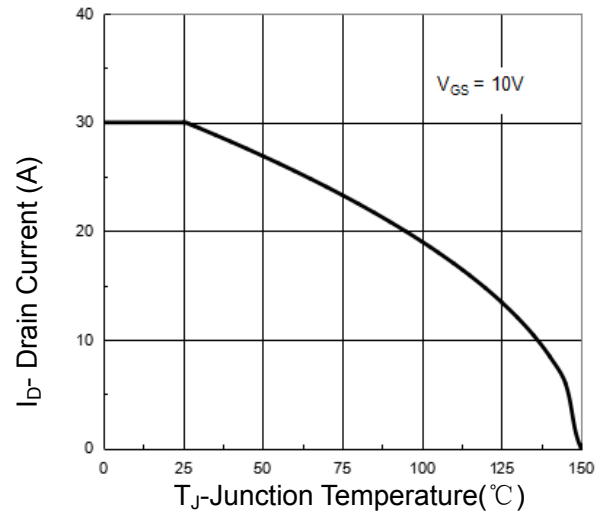


Figure 10 Current De-rating

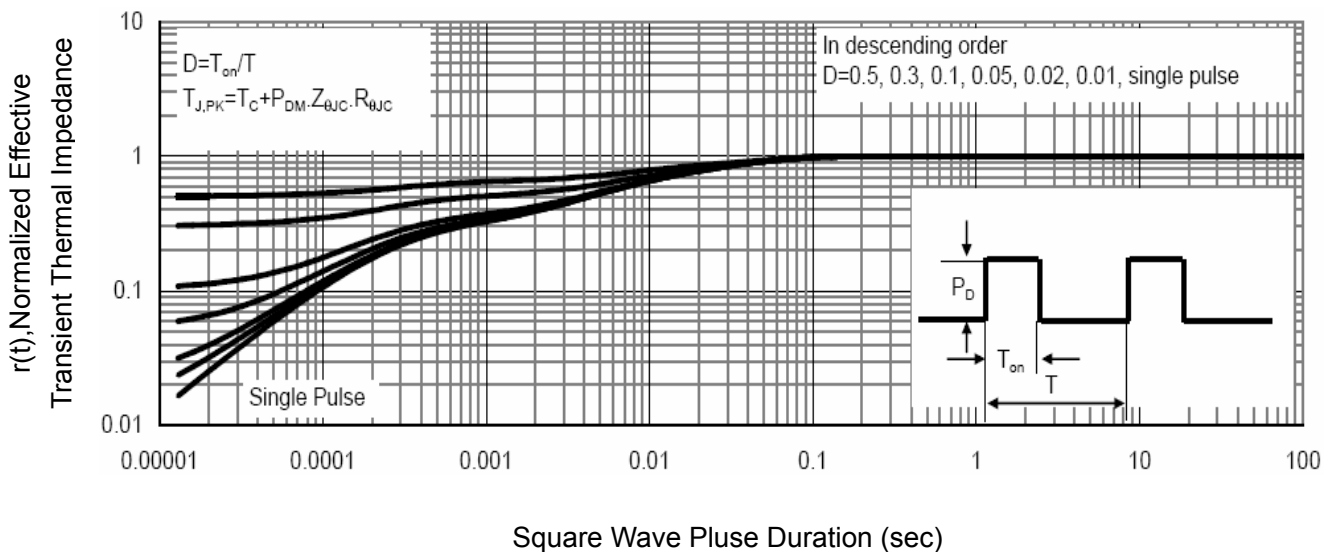


Figure 11 Normalized Maximum Transient Thermal Impedance

# P-Channel Typical Characteristics

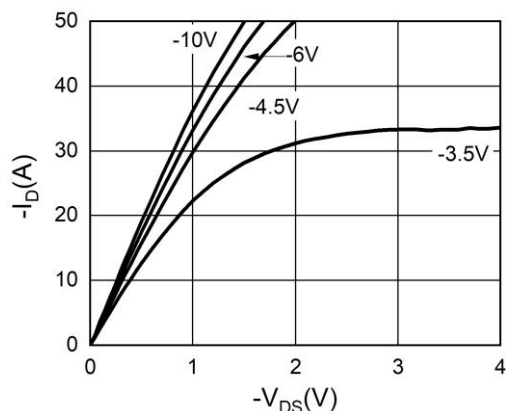
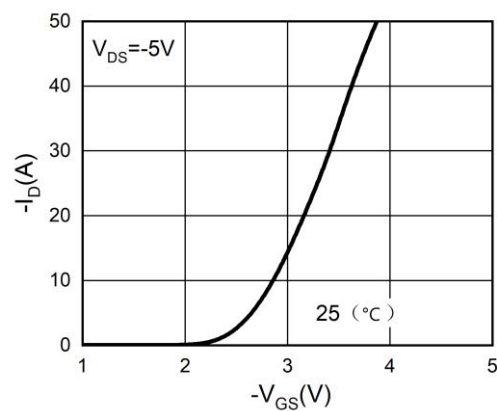
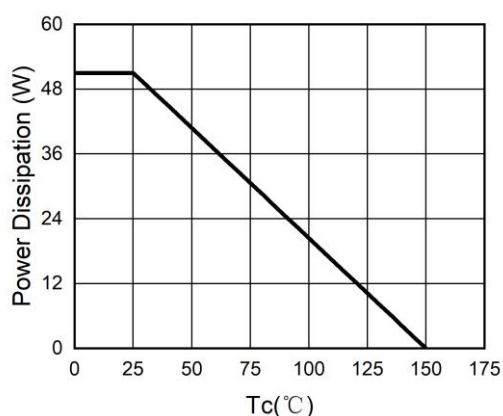
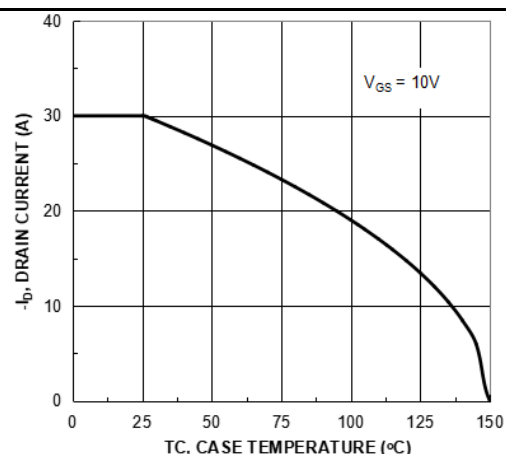
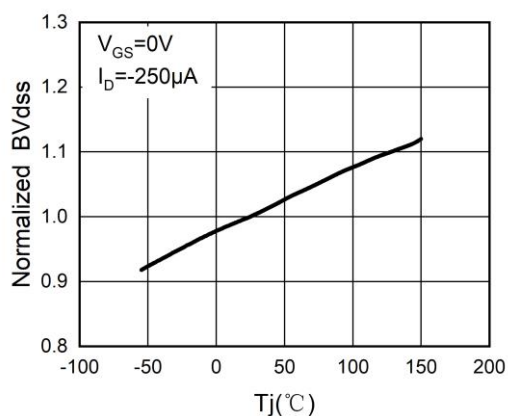
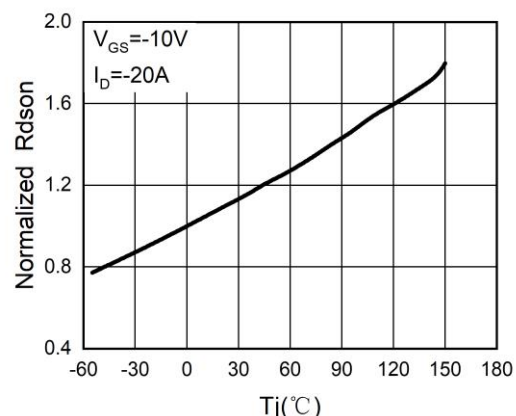
**Figure 1. Output Characteristics**

**Figure 2. Transfer Characteristics**

**Figure 3. Power Dissipation**

**Figure 4. Drain Current**

**Figure 5.  $BV_{DSS}$  vs Junction Temperature**

**Figure 6.  $R_{DS(ON)}$  vs Junction Temperature**


Figure 7. Gate Charge Waveforms

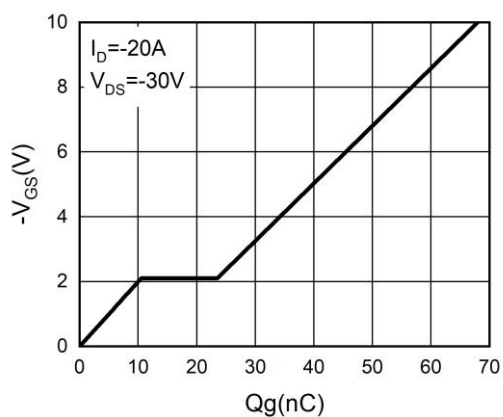


Figure 8. Capacitance

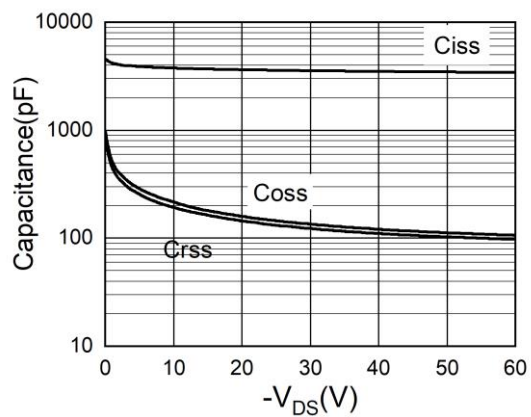


Figure 9. Body-Diode Characteristics

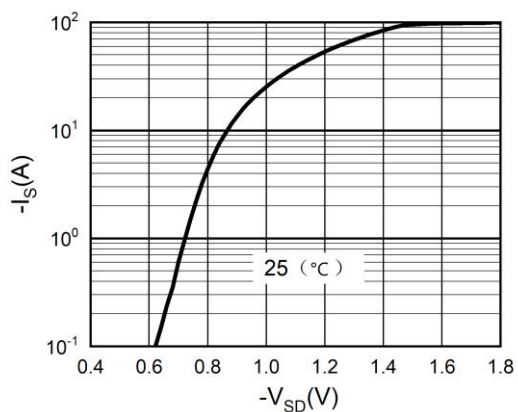
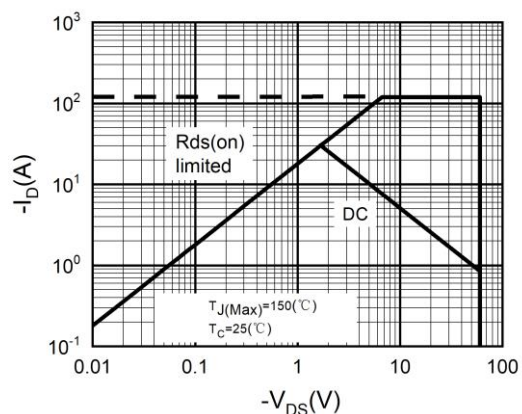
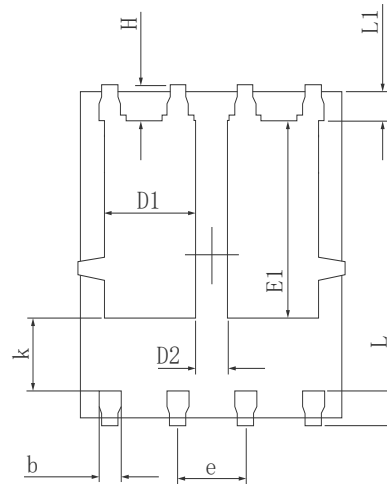
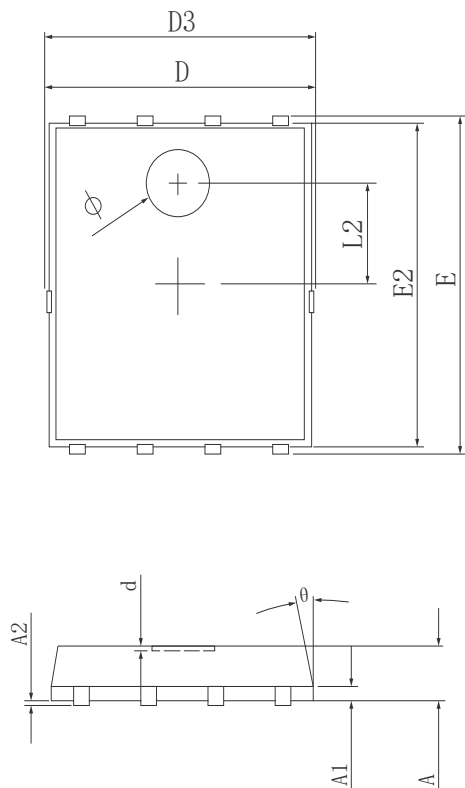


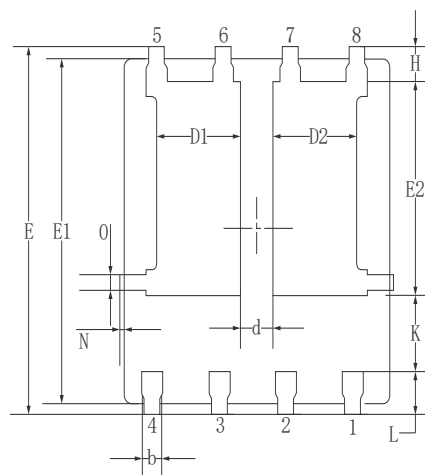
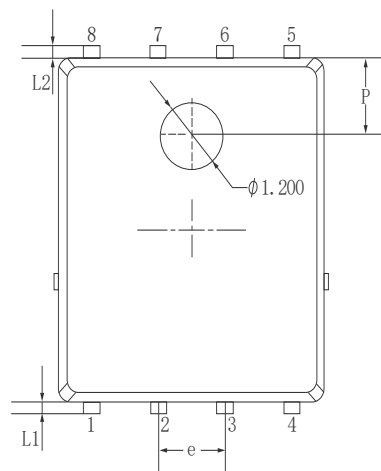
Figure 10. Maximum Safe Operating Area



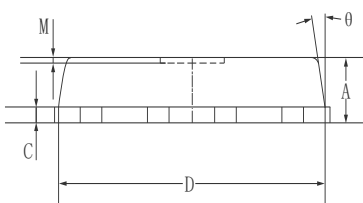
# Dimensions (PDFN5\*6)



| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | Typ.  | MAX   |
| A      | 0.900      | 1.000 | 1.100 |
| A1     | 0.254 REF. |       |       |
| A2     | 0°0.05     |       |       |
| D      | 4.824      | 4.900 | 4.976 |
| D1     | 1.605      | 1.705 | 1.805 |
| D2     | 0.500      | 0.600 | 0.700 |
| D3     | 4.924      | 5.000 | 5.076 |
| E      | 5.924      | 6.000 | 6.076 |
| E1     | 3.375      | 3.475 | 3.575 |
| E2     | 5.674      | 5.750 | 5.826 |
| b      | 0.350      | 0.400 | 0.450 |
| e      | 1.270 TYP. |       |       |
| L      | 0.534      | 0.610 | 0.686 |
| L1     | 0.424      | 0.500 | 0.576 |
| L2     | 1.800 REF. |       |       |
| k      | 1.190      | 1.290 | 1.390 |
| H      | 0.549      | 0.625 | 0.701 |
| θ      | 8°         | 10°   | 12°   |
| Φ      | 1.100      | 1.200 | 1.300 |
| d      |            |       | 0.100 |



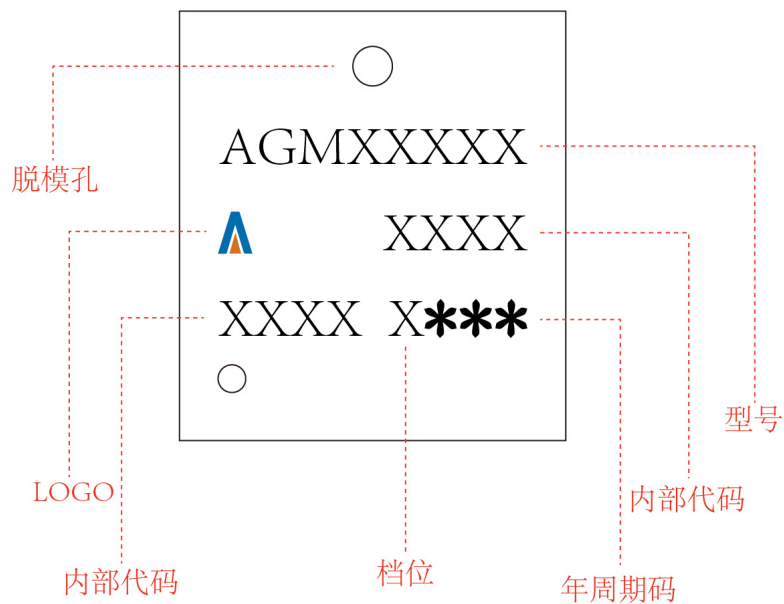
| Symbol | Millimeters |      |      |
|--------|-------------|------|------|
|        | MIN.        | NOM. | MAX. |
| A      | 0.90        | 1.05 | 1.20 |
| b      | 0.35        | 0.40 | 0.50 |
| C      | 0.20        | 0.25 | 0.35 |
| D      | 4.90        | 5.05 | 5.20 |
| D1/D2  | 1.51        | 1.61 | 1.71 |
| d      | 0.50        | 0.60 | 0.70 |
| E      | 6.00        | 6.15 | 6.30 |
| E1     | 5.60        | 5.75 | 5.90 |
| E2     | 3.47        | 3.57 | 3.67 |
| e      | 1.27 BSC.   |      |      |
| H      | 0.48        | 0.58 | 0.68 |
| K      | 1.17        | 1.27 | 1.37 |
| L      | 0.64        | 0.74 | 0.84 |
| L1/L2  | 0.20 REF.   |      |      |
| θ      | 8°          | 10°  | 12°  |
| M      | 0.08 REF.   |      |      |
| N      | 0           | -    | 0.15 |
| O      | 0.25 REF.   |      |      |
| P      | 1.28 REF.   |      |      |



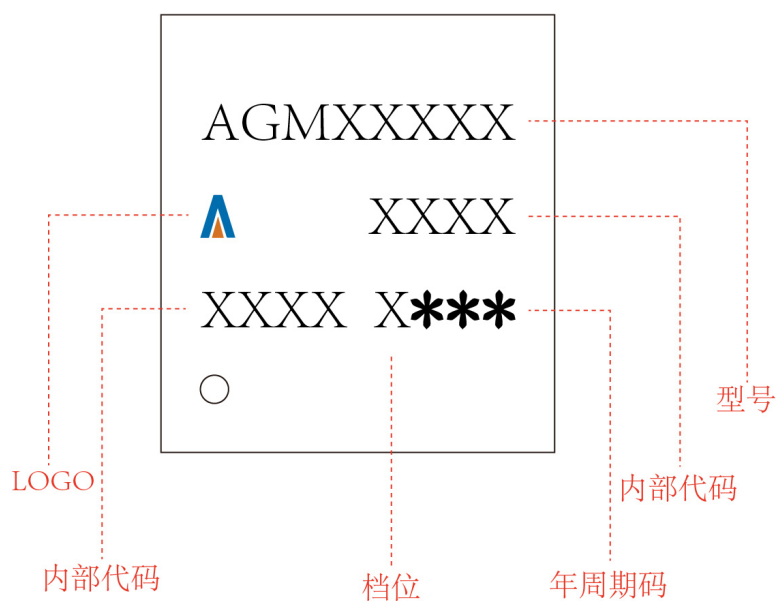
PDFN5\*6

Marking Instructions:

Model1:



Model2:



Disclaimer:

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